TPD4123AK

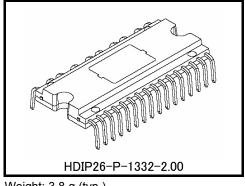
TOSHIBA Intelligent Power Device

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High Voltage Monolithic Silicon Power IC

TPD4123AK

The TPD4123AK is a DC brush less motor driver using high voltage PWM control. It is fabricated by high voltage SOI process. It is three-shunt resistor circuit for current sensing. It contains level shift high-side driver, low-side driver, IGBT outputs, FRDs and protective functions for under voltage protection circuits and thermal shutdown circuit. It is easy to control a DC brush less motor by just putting logic inputs from a MPU or motor controller to the TPD4123AK.



Weight: 3.8 g (typ.)

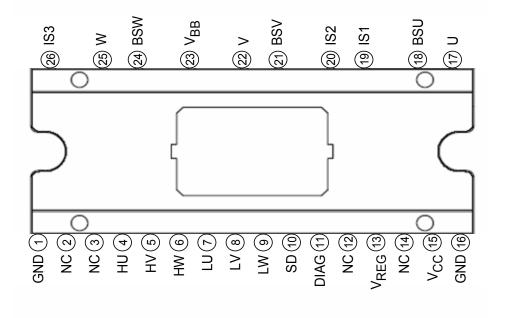
Features

- High voltage power side and low voltage signal side terminal are separated.
- It is the best for current sensing in three shunt resistance.
- Bootstrap circuit gives simple high-side supply.
- Bootstrap diodes are built in.
- A dead time can be set as a minimum of 1.4µs, and it is the best for a Sine-wave from drive.
- 3-phase bridge output using IGBTs.
- FRDs are built in.
- Included under voltage protection and thermal shutdown.
- The regulator of 7V (typ.) is built in.
- Package: 26-pin DIP.

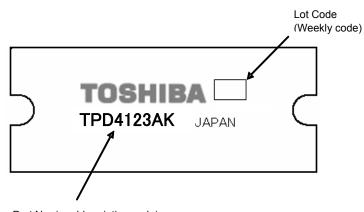
This product has a MOS structure and is sensitive to electrostatic discharge. When handling this product, ensure that the environment is protected against electrostatic discharge.

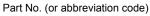
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Pin Assignment



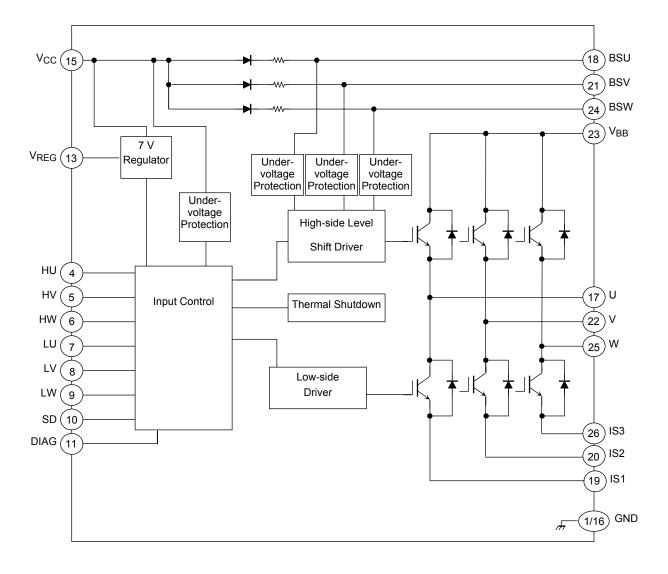
Marking





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Block Diagram



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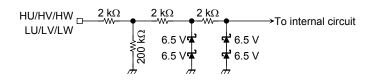
Pin Description

Pin No.	Symbol	Pin Description
1	GND	Ground pin.
2	NC	Unused pin, which is not connected to the chip internally.
3	NC	Unused pin, which is not connected to the chip internally.
4	HU	The control terminal of IGBT by the high side of U. It turns off less than 1.5V. It turns on more than 2.5V.
5	HV	The control terminal of IGBT by the high side of V. It turns off less than 1.5V. It turns on more than 2.5V.
6	HW	The control terminal of IGBT by the high side of W. It turns off less than 1.5V. It turns on more than 2.5V.
7	LU	The control terminal of IGBT by the low side of U. It turns off less than 1.5V. It turns on more than 2.5V.
8	LV	The control terminal of IGBT by the low side of V. It turns off less than 1.5V. It turns on more than 2.5V.
9	LW	The control terminal of IGBT by the low side of W. It turns off less than 1.5V. It turns on more than 2.5V.
10	SD	Input pin of external protection. ("L" active, It doesn't have hysteresis)
11	DIAG	With the diagnostic output terminal of open drain, a pull-up is carried out by resistance. It turns on at the time of unusual.
12	NC	Unused pin, which is not connected to the chip internally.
13	V _{REG}	7V regulator output pin.
14	NC	Unused pin, which is not connected to the chip internally.
15	V _{CC}	Control power supply pin. (15V typ.)
16	GND	Ground pin.
17	U	U-phase output pin.
18	BSU	U-phase bootstrap capacitor connecting pin.
19	IS1	U-phase IGBT emitter and FRD anode pin.
20	IS2	V-phase IGBT emitter and FRD anode pin.
21	BSV	V-phase bootstrap capacitor connecting pin.
22	V	V-phase output pin.
23	V _{BB}	High-voltage power supply input pin.
24	BSW	W-phase bootstrap capacitor connecting pin.
25	W	W-phase output pin.
26	IS3	W-phase IGBT emitter and FRD anode pin.

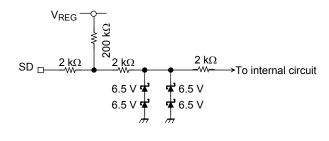
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Equivalent Circuit of Input Pins

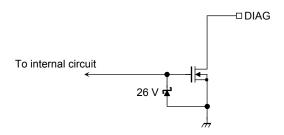
Internal circuit diagram of HU, HV, HW, LU, LV, LW input pins



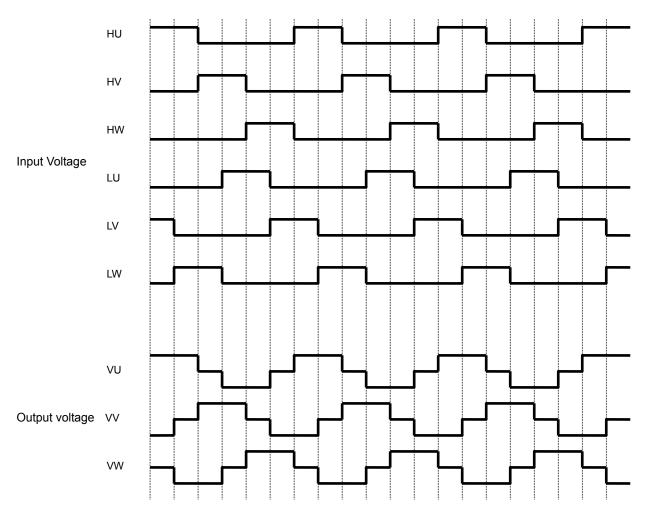
Internal circuit diagram of SD pin



Internal circuit diagram of DIAG pin



Timing Chart



TPD4123AK

Truth Table

				Input					High side			Low side		DIAG
Mode	ΗU	ΗV	HW	LU	LV	LW	SD	U phase	V phase	W phase	U phase	V phase	W phase	DIAG
Normal	Н	L	L	L	Н	L	Н	ON	OFF	OFF	OFF	ON	OFF	OFF
	Н	L	L	L	L	Н	Н	ON	OFF	OFF	OFF	OFF	ON	OFF
	L	Н	L	L	L	Н	Н	OFF	ON	OFF	OFF	OFF	ON	OFF
	L	Н	L	Н	L	L	Н	OFF	ON	OFF	ON	OFF	OFF	OFF
	L	L	Н	Н	L	L	Н	OFF	OFF	ON	ON	OFF	OFF	OFF
	L	L	Н	L	Н	L	Н	OFF	OFF	ON	OFF	ON	OFF	OFF
Thermal shutdown	Н	L	L	L	Н	L	Н	OFF	OFF	OFF	OFF	OFF	OFF	ON
	Н	L	L	L	L	Н	Н	OFF	OFF	OFF	OFF	OFF	OFF	ON
	L	Н	L	L	L	Н	Н	OFF	OFF	OFF	OFF	OFF	OFF	ON
	L	Н	L	Н	L	L	Н	OFF	OFF	OFF	OFF	OFF	OFF	ON
	L	L	Н	Н	L	L	Н	OFF	OFF	OFF	OFF	OFF	OFF	ON
	L	L	Н	L	Н	L	Н	OFF	OFF	OFF	OFF	OFF	OFF	ON
V _{CC} Under-voltage	Н	L	L	L	Н	L	Н	OFF	OFF	OFF	OFF	OFF	OFF	ON
	Н	L	L	L	L	Н	Н	OFF	OFF	OFF	OFF	OFF	OFF	ON
	L	Н	L	L	L	Н	Н	OFF	OFF	OFF	OFF	OFF	OFF	ON
	L	Н	L	Н	L	L	Н	OFF	OFF	OFF	OFF	OFF	OFF	ON
	L	L	Н	Н	L	L	Н	OFF	OFF	OFF	OFF	OFF	OFF	ON
	L	L	Н	L	Н	L	Н	OFF	OFF	OFF	OFF	OFF	OFF	ON
V_{BS} Under-voltage	Н	L	L	L	Н	L	Н	OFF	OFF	OFF	OFF	ON	OFF	OFF
	Н	L	L	L	L	Н	Н	OFF	OFF	OFF	OFF	OFF	ON	OFF
	L	Н	L	L	L	Н	Н	OFF	OFF	OFF	OFF	OFF	ON	OFF
	L	Н	L	Н	L	L	Н	OFF	OFF	OFF	ON	OFF	OFF	OFF
	L	L	Н	Н	L	L	Н	OFF	OFF	OFF	ON	OFF	OFF	OFF
	L	L	Н	L	Н	L	Н	OFF	OFF	OFF	OFF	ON	OFF	OFF
SD	*	*	*	*	*	*	L	OFF	OFF	OFF	OFF	OFF	OFF	ON

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Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Power supply voltage	V _{BB}	500	V
Power supply voltage	V _{CC}	18	V
Output current (DC)	IOUT	1	А
Output current (pulse)	I _{OUTp}	2	А
Input voltage	V _{IN}	-0.5 to 7	V
V _{REG} current	I _{REG}	50	mA
Power dissipation (Tc = 25°C)	PC	23	W
Operating temperature	Tjopr	-40 to 135	°C
Junction temperature	Тj	150	°C
Storage temperature	T _{stg}	-55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

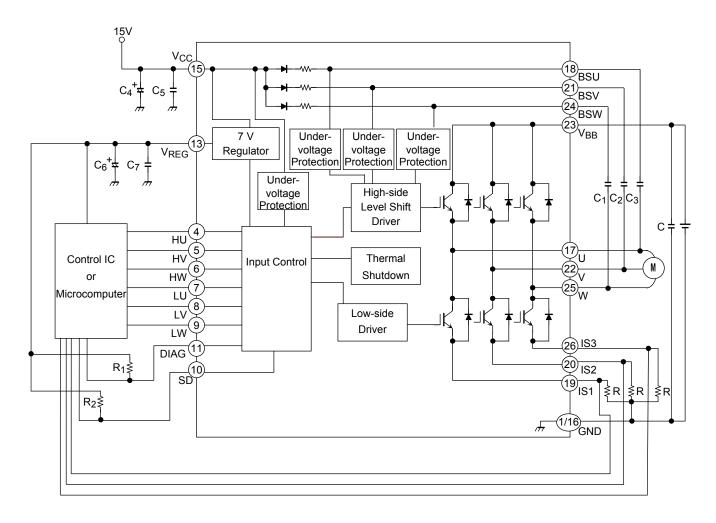
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Electrical Characteristics (Ta = 25°C)

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Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit	
Operating power supply voltage	V _{BB}	_	50	280	450	V	
operating power supply voltage	V _{CC}		13.5	15	16.5		
	I _{BB}	V _{BB} = 450 V	_	— — 0.5		mA	
Current discinction	ICC	V _{CC} = 15 V		0.9	5	IIIA	
Current dissipation	I _{BS (ON)}	V _{BS} = 15 V, high side ON		230	410	μA	
	I _{BS (OFF)}	$V_{BS} = 15 V$, high side OFF		200	370		
Innut voltogo	VIH	$V_{IN} = "H", V_{CC} = 15 V$	2.5			- v	
Input voltage	VIL	$V_{IN}=``L"$, $V_{CC}=15\ V$			1.5		
SD input voltage	V _{SD}	V _{CC} = 15 V		2.5		- V	
	IIН	$V_{IN} = 5 V$	—		150		
Input current	١ _{IL}	V _{IN} = 0 V	—		100	μA	
	I _{SDH}	$V_{IN} = 5 V$	—	—	100		
SD Input current	I _{SDL}	V _{IN} = 0 V	—	—	150	μA	
	V _{CEsat} H	$V_{CC} = 15 \text{ V}, I_C = 0.5 \text{ A}, \text{ high side}$	—	2.4	3		
Output saturation voltage	V _{CEsat} L	$V_{CC} = 15 \text{ V}, \text{ I}_{C} = 0.5 \text{ A}, \text{ low side}$	_	2.4	3	V	
	V _F H	I _F = 0.5 A, high side	—	1.5	2.0	- v	
FRD forward voltage	V _F L	I _F = 0.5 A, low side	_	1.5	2.0		
BSD forward voltage	V _{F (BSD)}	$I_F = 500 \ \mu A$	—	0.9	1.2	V	
Regulator voltage	V _{REG}	$V_{CC} = 15 \text{ V}, \text{ I}_{O} = 30 \text{ mA}$	6.5	7	7.5	V	
Thermal shutdown temperature	TSD	V _{CC} = 15 V	135	—	185	°C	
Thermal shutdown hysteresis	∆TSD	V _{CC} = 15 V	—	50		°C	
V _{CC} under voltage protection	V _{CC} UVD		10	11	12	V	
V _{CC} under voltage protection recovery	V _{CC} UVR		10.5	11.5	12.5	V	
V _{BS} under voltage protection	V _{BS} UVD		8	9	9.5	V	
V _{BS} under voltage protection recovery	V _{BS} UVR		8.5	9.5	10.5	V	
DIAG saturation voltage	V _{DIAGsat}	I _{DIAG} = 5 mA			0.5	V	
Output on delay time	t _{on}	$V_{BB} = 280 \text{ V}, \text{ V}_{CC} = 15 \text{ V}, \text{ I}_{C} = 0.5 \text{ A}$	_	1.4	3	μS	
Output off delay time	t _{off}	$V_{BB} = 280 \text{ V}, \text{ V}_{CC} = 15 \text{ V}, \text{ I}_{C} = 0.5 \text{ A}$		1.0	3	μS	
Dead time	t _{dead}	$V_{BB} = 280 \text{ V}, \text{ V}_{CC} = 15 \text{ V}, \text{ I}_{C} = 0.5 \text{ A}$	1.4			μS	
FRD reverse recovery time	t _{rr}	$V_{BB} = 280 \text{ V}, \text{ V}_{CC} = 15 \text{ V}, \text{ I}_{C} = 0.5 \text{ A}$	_	200		ns	

Application Circuit Example



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External Parts

Typical external parts are shown in the following table.

Part	Typical	Purpose	Remarks
C ₁ , C ₂ , C ₃	25 V/2.2 μF	Bootstrap capacitor	(Note 1)
C ₄	25 V/10 μF	V _{CC} power supply stability	(Note 2)
C ₅	25 V/0.1 μF	V_{CC} for surge absorber	(Note 2)
C ₆	25 V/1 μF	V _{REG} power supply stability	(Note 2)
C ₇	25 V/1000 pF	V _{REG} for surge absorber	(Note 2)
R ₁	5.1 kΩ	DIAG pin pull-up resistor	(Note 3)
R ₂	10 kΩ	SD pin pull-up resistor	

- Note 1: The required bootstrap capacitance value varies according to the motor drive conditions. The capacitor is biased by V_{CC} and must be sufficiently derated for it.
- Note 2: When using this product, adjustment is required in accordance with the use environment. When mounting, place as close to the base of this product leads as possible to improve the ripple and noise elimination.
- Note 3: The DIAG pin is open drain. If not using the DIAG pin, connect to the GND.

Handling precautions

- Please control the input signal in the state to which the V_{CC} voltage is steady. Both of the order of the V_{BB} power supply and the V_{CC} power supply are not cared about either.
 Note that if the power supply is switched off as described above, this product may be destroyed if the current regeneration route to the V_{BB} power supply is blocked when the V_{BB} line is disconnected by a relay or similar while the motor is still running.
- (2) The excess voltage such as the voltage surge which exceed the maximum rating is added, for example, may destroy the circuit. Accordingly, be careful of handling this product or of surge voltage in its application environment.

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Description of Protection Function

(1) Under voltage protection

This product incorporates under voltage protection circuits to prevent the IGBT from operating in unsaturated mode when the V_{CC} voltage or the V_{BS} voltage drops.

When the V_{CC} power supply falls to this product internal setting V_{CC}UVD (=11 V typ.), all IGBT outputs shut down regardless of the input. This protection function has hysteresis. When the V_{CC} power supply reaches 0.5 V higher than the shutdown voltage (V_{CC}UVR (=11.5 V typ.)), this product is automatically restored and the IGBT is turned on again by the input. DIAG output is reversed at the time of V_{CC} under-voltage protection. When the V_{CC} power supply is less than 7 V, DIAG output isn't sometimes reversed.

When the V_{BS} supply voltage drops V_{BS}UVD (=9 V typ.), the high-side IGBT output shuts down.

When the V_{BS} supply voltage reaches 0.5 V higher than the shutdown voltage (V_{BS}UVR (=9.5 V typ.)), the IGBT is turned on again by the input signal.

(2) Thermal shutdown

This product incorporates a thermal shutdown circuit to protect itself against the abnormal state when its temperature rises excessively.

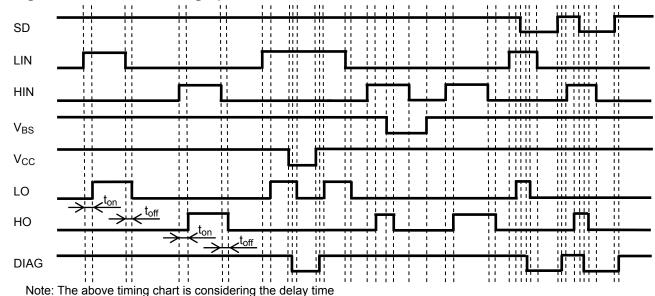
When the temperature of this chip rises to the internal setting TSD due to external causes or internal heat generation, all IGBT outputs shut down regardless of the input. This protection function has hysteresis Δ TSD (=50°C typ.). When the chip temperature falls to TSD – Δ TSD, the chip is automatically restored and the IGBT is turned on again by the input.

Because the chip contains just one temperature detection location, when the chip heats up due to the IGBT, for example, the differences in distance from the detection location in the IGBT (the source of the heat) cause differences in the time taken for shutdown to occur. Therefore, the temperature of the chip may rise higher than the thermal shutdown temperature when the circuit started to operate.

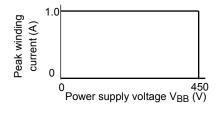
(3) SD pin

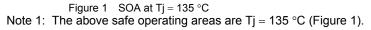
SD pin is the input signal pin to shut down the internal output IGBT. Output of all IGBT is shuted down after delay times (2 μ s typ.) when "L" signal is inputed to the SD pin from external circuit (MCU etc.). It is possible to shut down IC when overcurrent and others is detected by external circuit. Shut down state is released by all of IC input signal "L". At open state of SD pin, shut down function can not operate.

Timing Chart of Under voltage protection and SD Function

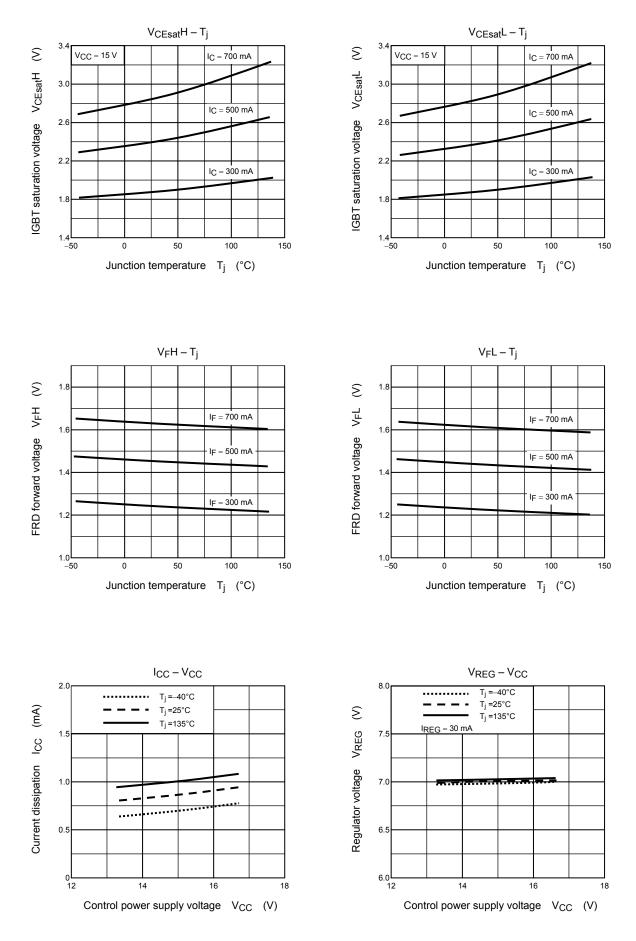


Safe Operating Area

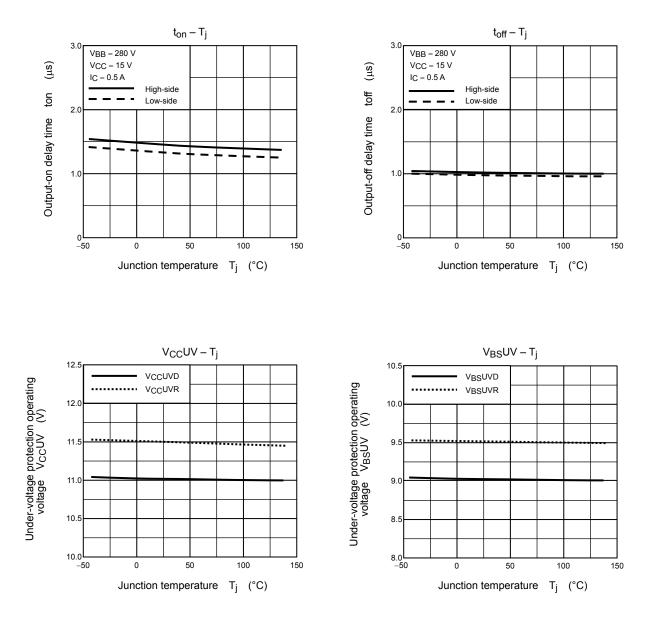


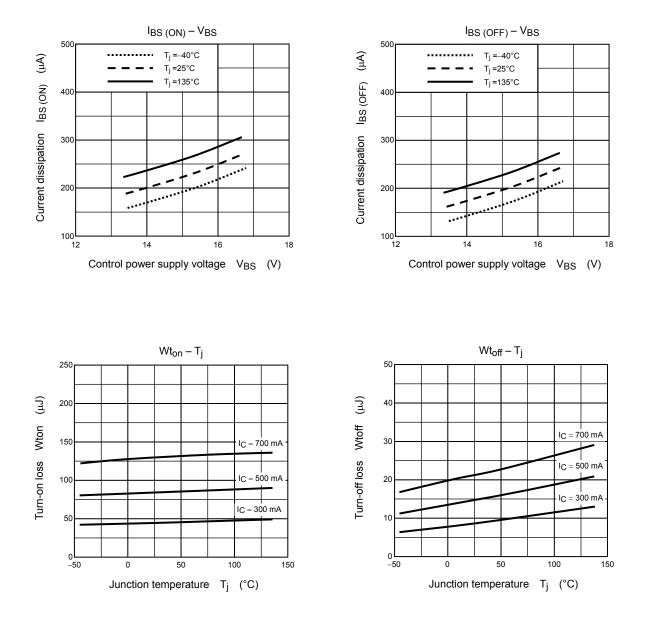


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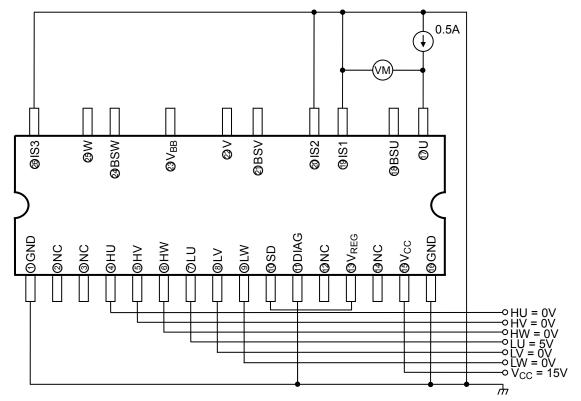




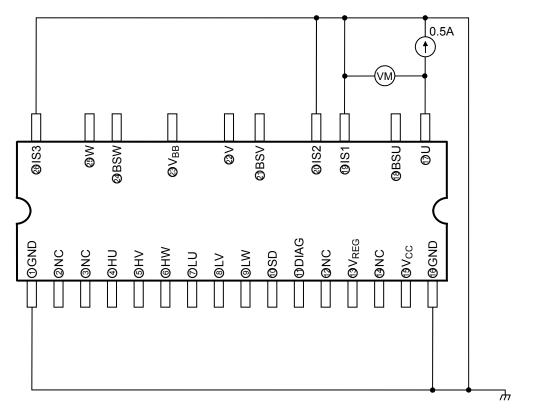
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Test Circuits

IGBT Saturation Voltage (U-phase low side)



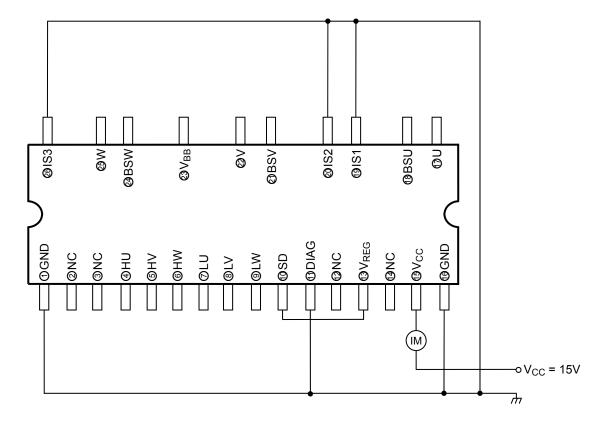
FRD Forward Voltage (U-phase low side)



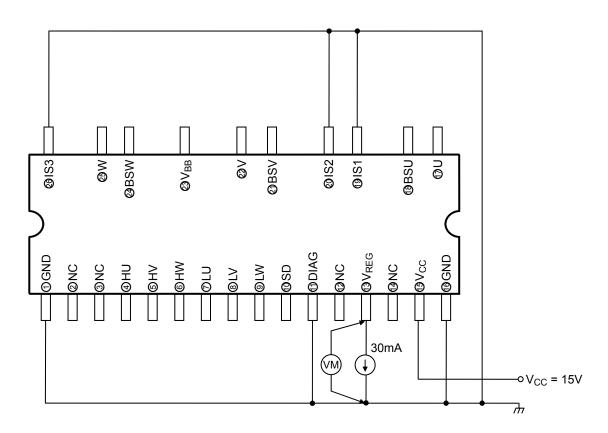
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V_{CC} Current Dissipation

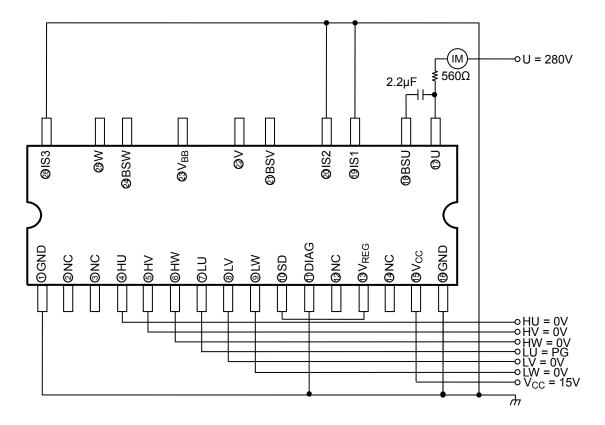


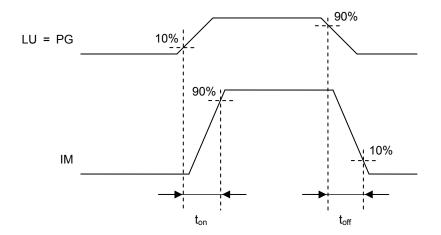
Regulator Voltage



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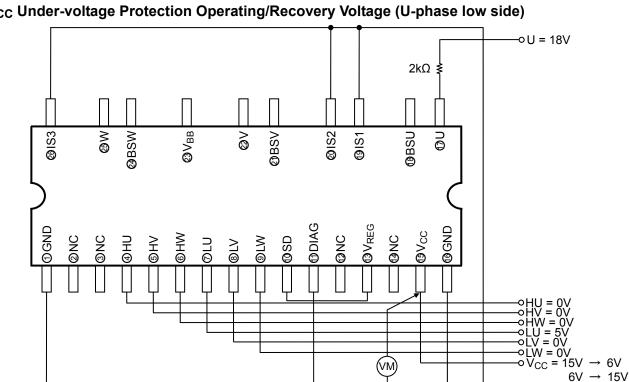
Output ON/OFF Delay Time (U-phase low side)





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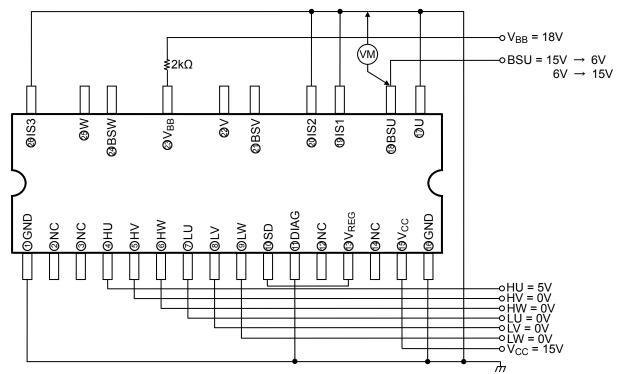


V_{CC} Under-voltage Protection Operating/Recovery Voltage (U-phase low side)

*Note: Sweeps the V_{CC} pin voltage from 15 V and monitors the U pin voltage.

The V_{CC} pin voltage when output is off defines the under-voltage protection operating voltage. Also sweeps from 6 V to increase. The V_{CC} pin voltage when output is on defines the under voltage protection recovery voltage.

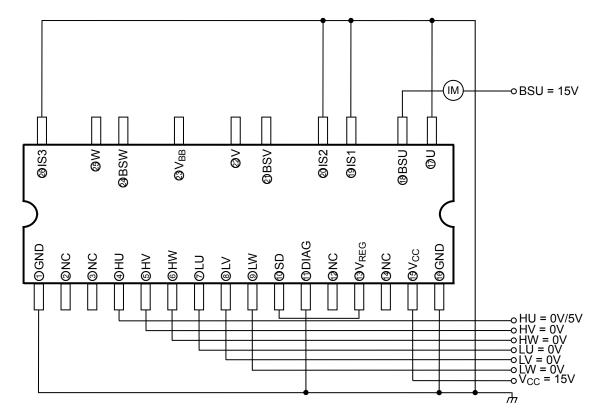
V_{BS} Under-voltage Protection Operating/Recovery Voltage (U-phase high side)



*Note: Sweeps the BSU pin voltage from 15 V to decrease and monitors the VBB pin voltage. The BSU pin voltage when output is off defines the under voltage protection operating voltage. Also sweeps the BSU pin voltage from 6V to increase and change the HU pin voltage at 5 V \rightarrow 0 V \rightarrow 5 V each time. It repeats similarly output is on. When the BSU pin voltage when output is on defines the under voltage protection recovery voltage.

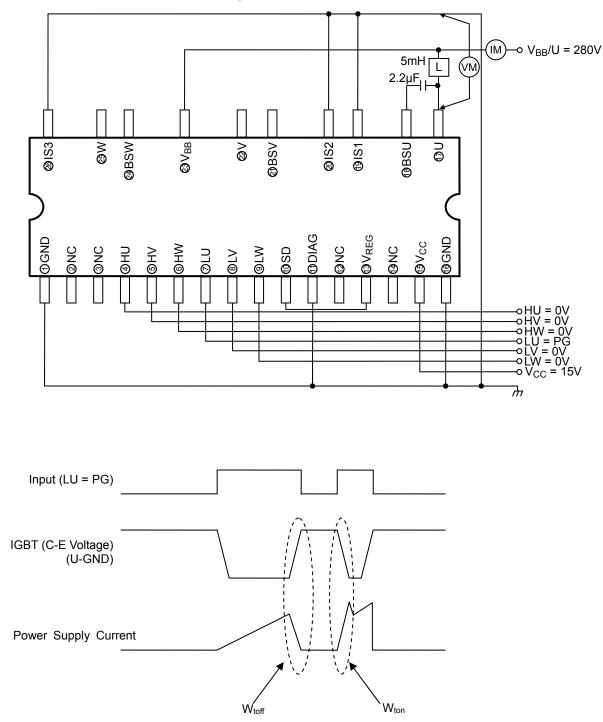
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V_{BS} Current Dissipation (U-phase high side)



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Turn-On/Off Loss (low side IGBT + high side FRD)



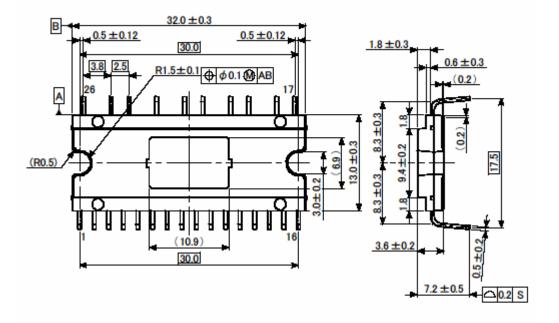
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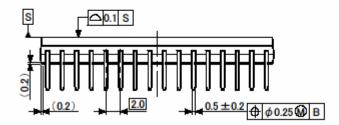
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Package Dimensions

HDIP26-P-1332-2.00

Unit : mm





Weight: 3.8 g (typ.)

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RESTRICTIONS ON PRODUCT USE

20070701-EN GENERAL

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